

COM Express®

cExpress-HL User's Manual



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ADLINK
TECHNOLOGY INC.

Revision History

Revision	Description	Date	By
0.10	Preliminary release	2013-12-25	JC

Preface

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1 Introduction

The cExpress-HL is a COM Express® COM.0 R2.1 Type 6 Compact size module supporting the 64-bit 4th Generation Intel® Core™ i7/i5/3 U-Series Processors with CPU, memory controller, graphics processor and I/O hub on the same chip. Leveraging the benefits provided by the Intel® Core™ i7/i5/3 U-Series System-on-Chip, the cExpress-HL is specifically designed for customers who need optimum processing and graphics performance with low power consumption in a long product life solution.

The cExpress-HL features the Intel® Core™ i7/i5/i3 processor supporting Intel® Hyper-Threading Technology (up to 2 cores, 4 threads) and up to 16 GB of DDR3L dual-channel memory at 1333/1600 MHz in dual stacked SODIMM sockets to provide excellent overall performance.

Integrated Intel Generation 7.5 Graphics includes features such as OpenGL 3.1, DirectX 11, Intel® Clear Video HD Technology, Advanced Scheduler 2.0, 1.0, XPDM support, and DirectX Video Acceleration (DXVA) support for full AVC/VC1/MPEG2 hardware decode. Graphics outputs include dual-channel 18/24-bit LVDS and two DDI ports supporting HDMI / DVI / DisplayPort. The cExpress-HL is specifically designed for customers with high-performance processing graphics requirements who want to outsource the custom core logic of their systems for reduced development time.

The cExpress-HL features a single onboard Gigabit Ethernet port, two USB 3.0 ports and six USB 2.0 ports, and 4 SATA 6 Gb/s ports. Support is provided for SMBus and I2C. The module is equipped with SPI AMI EFI BIOS with CMOS backup, supporting embedded features such as remote console, CMOS backup, hardware monitor, and watchdog timer.

2 Specifications

2.1 Core System

➤ **CPU:** Haswell ULT (Ultra Low TDP) SOC

- Intel® Core™ i7-4650U 1.7 GHz (3.3 GHz Turbo), 15W (2C/GT3)
- Intel® Core™ i5-4300U 1.9 GHz (2.9 GHz Turbo), 15W (2C/GT2)
- Intel® Core™ i3-4010U 1.7 GHz (no Turbo) 3MB, 15W (2C/GT2)
- Intel® Celeron® 2980U 1.6 GHz (no Turbo), 15W (2C/HDG)

Supporting: Intel® VT, Intel® TXT, Intel® SSE4.2, Intel® HT Technology, Intel® 64 Architecture, Execute Disable Bit, Intel® Turbo Boost Technology 2.0, Intel® AVX2, Intel® AES-NI, PCLMULQDQ Instruction, Intel® Secure Key and Intel® TSX

- **L3 Cache:** 4MB for Core™ i7-4650U, 3MB for Core™ i5-4300U and Core™ i3-4010U, 2MB for Celeron® 2980U
- **Memory:** Dual channel non-ECC 1600/1333 MHz DDR3L memory up to 16 GB in dual SODIMM socket
- **BIOS:** AMI EFI with CMOS backup in 8MB SPI BIOS with Intel® AMT 9.0 support

2.2 Expansion Busses

- 4 PCI Express x1 (AB): Lanes 0/1/2/3
- LPC bus, SMBus (system) , I²C (user)

2.3 Video

➤ **Integrated in Processor:** Intel® Generation 7.5 graphics core architecture

➤ **GPU Feature Support:**

- 3 independent and simultaneous display combinations of DisplayPort / HDMI / LVDS monitors
- Encode/transcode HD content
- Playback of high definition content including Blu-ray Disc
- Superior image quality with sharper, more colorful images
- Playback of Blu-ray disc S3D content using HDMI (1.4a spec compliant with 3D)
- DirectX Video Acceleration (DXVA) support for accelerating video processing
- Full AVC/VC1/MPEG2 HW decode
- Advanced Scheduler 2.0, 1.0, XPDM support
- Windows 8, Windows 7, OSX, Linux OS support
- DirectX 11
- Multi Display Support: 3 independent displays

➤ **Display Types**

- LVDS interface single/dual channel 18/24-bit LVDS through eDP (two lane) to LVDS Realtek RTD2136R
- Digital Display Ports x2
 - DDI1 supports DisplayPort / HDMI / DVI
 - DDI2 supports DisplayPort / HDMI / DVI

2.4 Audio

- **Integrated:** Intel® HD Audio integrated in PCH QM87
- **Codec:** Realtek ALC886 on Express-BASE6

2.5 LAN

- **Integrated:** MAC integrated in SOC
- **Intel PHY:** Intel® Ethernet Controller i218LM
- **Interface:** 10/100/1000 GbE connection

2.6 Multi I/O and Storage

- **Integrated:** in SOC
- **USB ports:** 2 ports USB 3.0 (USB0,1) and 6 ports USB 2.0 (USB2,3,4,5,6,7)
- **SATA ports:** four ports SATA 6Gb/s (SATA0, SATA1, SATA2, SATA3)
- **GPIO:** 4 GPO and 4 GPI with interrupt

2.7 Serial I/O on Module

- **Chipset:** Nuvoton NCT5104D
- **Ports:** two UARTs RX/TX only
- **Console Redirection:** selectable in BIOS over UART0 or UART1

2.8 TPM (Trusted Platform Module)

- **Chipset:** ATMEL AT97SC3204
- **Type:** TPM 1.2

2.9 SEMA Board Controller

- **Type:** ADLINK Smart Embedded Management Agent (SEMA)
- **Supports:**
 - Voltage/Current monitoring
 - Power sequence debug support
 - AT/ATX mode control
 - Logistics and Forensic information
 - Flat Panel Control
 - General Purpose I2C
 - Failsafe BIOS (dual BIOS)
 - Watchdog Timer and Fan Control

2.10 Debug

- 40-pin flat cable connector to be used with DB-40 debug module
Supports: BIOS POST code LED, BMC access, SPI BIOS flashing, power testpoints, debug LEDs
- 60-pin XDP header for ICE debug of CPU/chipset

2.11 Power Specifications

- **Power Modes:** AT and ATX mode (AT mode start controlled by SMC)
- **Standard Voltage Input:** ATX = 12V±5% / 5Vsb ±5% or AT = 12V±5%
- **Wide Voltage Input:** ATX = 5-20 V / 5Vsb ±5% or AT = 5 ~20V
- **Power Management:** ACPI 4.0 compliant, Smart Battery support
- **Power States:** supporting C1-C6, S0, S1, S4, S3, S5 (Wake on USB S3/S4, WOL S3/S4/S5)
- **ECO mode** supports deep S5 (ECO mode)

2.12 Operating Temperatures

- **Standard Operating Temperature:** 0°C to +60°C (Wide Voltage Input)
- **Industrial Operating Temperature (optional):** -20°C to +70°C (Wide Voltage Input)
- **Extreme Rugged Operating Temperature (optional):** -40°C to +85°C (Standard Voltage Input)

2.13 Environmental

- **Humidity:** 5-90% RH operating, non-condensing
5-95% RH storage (and operating with conformal coating).
- **Shock and Vibration:** IEC 60068-2-64 and IEC-60068-2-27
MIL-STD-202F, Method 213B, Table 213-I, Condition A and Method 214A, Table 214-I, Condition D
- **Halt:** Thermal Stress, Vibration Stress, Thermal Shock and Combined Test

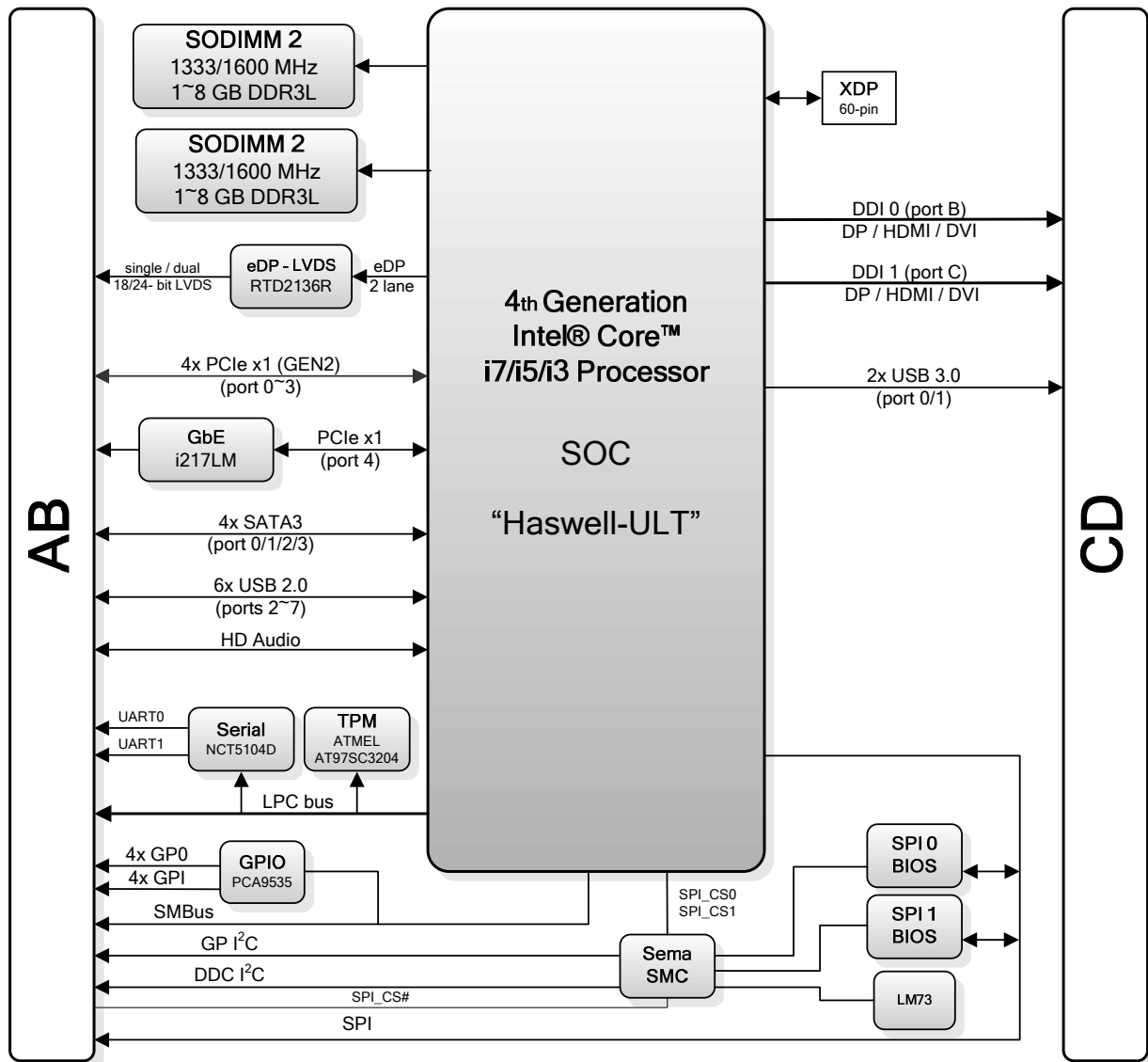
2.14 Specification Compliance

- PICMG COM.0: Rev 2.1 Type 6, Basic size 125 x 95 mm

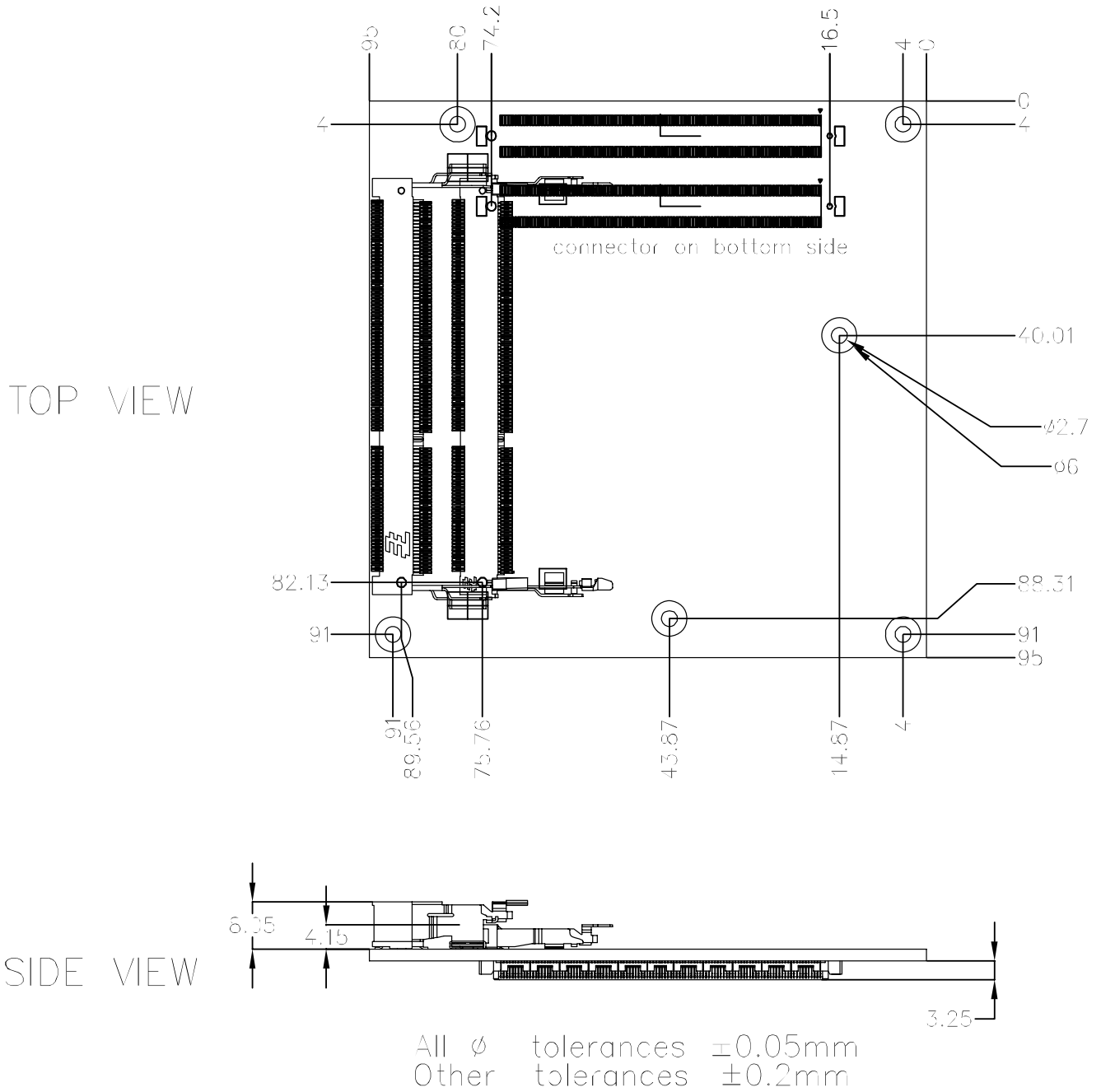
2.15 Operating Systems

- **Standard Support:** Windows 7/8 32/64-bit, Linux 32/64-bit
- **Extended Support (BSP):** WEC7/8, Linux , VxWorks

2.16 Function Diagram



2.17 Mechanical Drawing



3 Pinouts and Signal Descriptions

3.1 AB / CD Pin Definitions

The cExpress-HL is a Type 6 module supporting USB 3.0 and DDI channels on the CD connector

All pins in the COM Express specification are described, including those not supported on the cExpress-HL. Those not supported on the cExpress-HL module are crossed out

Row A		Row B		Row C		Row D	
Pin	Name	Pin	Name	Pin	Name	Pin	Name
A1	GND (FIXED)	B1	GND (FIXED)	C1	GND (FIXED)	D1	GND (FIXED)
A2	GBE0_MDI3-	B2	GBE0_ACT#	C2	GND	D2	GND
A3	GBE0_MDI3+	B3	LPC_FRAME#	C3	USB_SSRX0-	D3	USB_SSTX0-
A4	GBE0_LINK100#	B4	LPC_AD0	C4	USB_SSRX0+	D4	USB_SSTX0+
A5	GBE0_LINK1000#	B5	LPC_AD1	C5	GND	D5	GND
A6	GBE0_MDI2-	B6	LPC_AD2	C6	USB_SSRX1-	D6	USB_SSTX1-
A7	GBE0_MDI2+	B7	LPC_AD3	C7	USB_SSRX1+	D7	USB_SSTX1+
A8	GBE0_LINK#	B8	LPC_DRQ0#	C8	GND	D8	GND
A9	GBE0_MDI1-	B9	LPC_DRQ1#	C9	USB_SSRX2-	D9	USB_SSTX2-
A10	GBE0_MDI1+	B10	LPC_CLK	C10	USB_SSRX2+	D10	USB_SSTX2+
A11	GND (FIXED)	B11	GND (FIXED)	C11	GND (FIXED)	D11	GND (FIXED)
A12	GBE0_MDI0-	B12	PWRBTN#	C12	USB_SSRX3-	D12	USB_SSTX3-
A13	GBE0_MDI0+	B13	SMB_CK	C13	USB_SSRX3+	D13	USB_SSTX3+
A14	GBE0_CTREF	B14	SMB_DAT	C14	GND	D14	GND
A15	SUS_S3#	B15	SMB_ALERT#	C15	DDI1_PAIR6+	D15	DDI1_CTRLCLK_AUX+
A16	SATA0_TX+	B16	SATA1_TX+	C16	DDI1_PAIR6-	D16	DDI1_CTRLDATA_AUX
A17	SATA0_TX-	B17	SATA1_TX-	C17	RSVD	D17	RSVD
A18	SUS_S4#	B18	SUS_STAT#	C18	RSVD	D18	RSVD
A19	SATA0_RX+	B19	SATA1_RX+	C19	PCIE_RX6+	D19	PCIE_TX6+
A20	SATA0_RX-	B20	SATA1_RX-	C20	PCIE_RX6-	D20	PCIE_TX6-
A21	GND (FIXED)	B21	GND (FIXED)	C21	GND (FIXED)	D21	GND (FIXED)
A22	SATA2_TX+	B22	SATA3_TX+	C22	PCIE_RX7+	D22	PCIE_TX7+
A23	SATA2_TX-	B23	SATA3_TX-	C23	PCIE_RX7-	D23	PCIE_TX7-
A24	SUS_S5#	B24	PWR_OK	C24	DDI1_HPD	D24	RSVD
A25	SATA2_RX+	B25	SATA3_RX+	C25	DDI1_PAIR4+	D25	RSVD
A26	SATA2_RX-	B26	SATA3_RX-	C26	DDI1_PAIR4-	D26	DDI1_PAIR0+
A27	BATLOW#	B27	WDT	C27	RSVD	D27	DDI1_PAIR0-
A28	(S)ATA_ACT#	B28	AC/HDA_SDIN2	C28	RSVD	D28	RSVD
A29	AC/HDA_SYNC	B29	AC/HDA_SDIN1	C29	DDI1_PAIR5+	D29	DDI1_PAIR1+
A30	AC/HDA_RST#	B30	AC/HDA_SDIN0	C30	DDI1_PAIR5-	D30	DDI1_PAIR1-
A31	GND (FIXED)	B31	GND (FIXED)	C31	GND (FIXED)	D31	GND (FIXED)
A32	AC/HDA_BITCLK	B32	SPKR	C32	DDI2_CTRLCLK_AUX+	D32	DDI1_PAIR2+
A33	AC/HDA_SDOUT	B33	I2C_CK	C33	DDI2_CTRLDATA_AUX-	D33	DDI1_PAIR2-
A34	BIOS_DIS0#	B34	I2C_DAT	C34	DDI2_DDC_AUX_SEL	D34	DDI1_DDC_AUX_SEL
A35	THRMTRIP#	B35	THRM#	C35	RSVD	D35	RSVD

Row A		Row B		Row C		Row D	
Pin	Name	Pin	Name	Pin	Name	Pin	Name
A36	USB6-	B36	USB7-	C36	DDI3_CTRLCLK_AUX+	D36	DDI1_PAIR3+
A37	USB6+	B37	USB7+	C37	DDI3_CTRLDATA_AUX-	D37	DDI1_PAIR3-
A38	USB_6_7_OC#	B38	USB_4_5_OC#	C38	DDI3_DDC_AUX_SEL	D38	RSVD
A39	USB4-	B39	USB5-	C39	DDI3_PAIR0+	D39	DDI2_PAIR0+
A40	USB4+	B40	USB5+	C40	DDI3_PAIR0-	D40	DDI2_PAIR0-
A41	GND (FIXED)	B41	GND (FIXED)	C41	GND (FIXED)	D41	GND (FIXED)
A42	USB2-	B42	USB3-	C42	DDI3_PAIR1+	D42	DDI2_PAIR1+
A43	USB2+	B43	USB3+	C43	DDI3_PAIR1-	D43	DDI2_PAIR1-
A44	USB_2_3_OC#	B44	USB_0_1_OC#	C44	DDI3_HPD	D44	DDI2_HPD
A45	USB0-	B45	USB1-	C45	RSVD	D45	RSVD
A46	USB0+	B46	USB1+	C46	DDI3_PAIR2+	D46	DDI2_PAIR2+
A47	VCC_RTC	B47	EXCD1_PERST#	C47	DDI3_PAIR2-	D47	DDI2_PAIR2-
A48	EXCD0_PERST#	B48	EXCD1_CPPE#	C48	RSVD	D48	RSVD
A49	EXCD0_CPPE#	B49	SYS_RESET#	C49	DDI3_PAIR3+	D49	DDI2_PAIR3+
A50	LPC_SERIRQ	B50	CB_RESET#	C50	DDI3_PAIR3-	D50	DDI2_PAIR3-
A51	GND (FIXED)	B51	GND (FIXED)	C51	GND (FIXED)	D51	GND (FIXED)
A52	PCIE_TX5+	B52	PCIE_RX5+	C52	PEG_RX0+	D52	PEG_TX0+
A53	PCIE_TX5-	B53	PCIE_RX5-	C53	PEG_RX0-	D53	PEG_TX0-
A54	GPI0	B54	GPO1	C54	TYPE0#	D54	PEG_LANE_RV#
A55	PCIE_TX4+	B55	PCIE_RX4+	C55	PEG_RX1+	D55	PEG_TX1+
A56	PCIE_TX4-	B56	PCIE_RX4-	C56	PEG_RX1-	D56	PEG_TX1-
A57	GND	B57	GPO2	C57	TYPE1#	D57	TYPE2#
A58	PCIE_TX3+	B58	PCIE_RX3+	C58	PEG_RX2+	D58	PEG_TX2+
A59	PCIE_TX3-	B59	PCIE_RX3-	C59	PEG_RX2-	D59	PEG_TX2-
A60	GND (FIXED)	B60	GND (FIXED)	C60	GND (FIXED)	D60	GND (FIXED)
A61	PCIE_TX2+	B61	PCIE_RX2+	C61	PEG_RX3+	D61	PEG_TX3+
A62	PCIE_TX2-	B62	PCIE_RX2-	C62	PEG_RX3-	D62	PEG_TX3-
A63	GPI1	B63	GPO3	C63	RSVD	D63	RSVD
A64	PCIE_TX1+	B64	PCIE_RX1+	C64	RSVD	D64	RSVD
A65	PCIE_TX1-	B65	PCIE_RX1-	C65	PEG_RX4+	D65	PEG_TX4+
A66	GND	B66	WAKE0#	C66	PEG_RX4-	D66	PEG_TX4-
A67	GPI2	B67	WAKE1#	C67	RSVD	D67	GND
A68	PCIE_TX0+	B68	PCIE_RX0+	C68	PEG_RX5+	D68	PEG_TX5+
A69	PCIE_TX0-	B69	PCIE_RX0-	C69	PEG_RX5-	D69	PEG_TX5-
A70	GND (FIXED)	B70	GND (FIXED)	C70	GND (FIXED)	D70	GND (FIXED)
A71	LVDS_A0+	B71	LVDS_B0+	C71	PEG_RX6+	D71	PEG_TX6+
A72	LVDS_A0-	B72	LVDS_B0-	C72	PEG_RX6-	D72	PEG_TX6-
A73	LVDS_A1+	B73	LVDS_B1+	C73	GND	D73	GND
A74	LVDS_A1-	B74	LVDS_B1-	C74	PEG_RX7+	D74	PEG_TX7+
A75	LVDS_A2+	B75	LVDS_B2+	C75	PEG_RX7-	D75	PEG_TX7-
A76	LVDS_A2-	B76	LVDS_B2-	C76	GND	D76	GND
A77	LVDS_VDD_EN	B77	LVDS_B3+	C77	RSVD	D77	RSVD
A78	LVDS_A3+	B78	LVDS_B3-	C78	PEG_RX8+	D78	PEG_TX8+
A79	LVDS_A3-	B79	LVDS_BKLT_EN	C79	PEG_RX8-	D79	PEG_TX8-
A80	GND (FIXED)	B80	GND (FIXED)	C80	GND (FIXED)	D80	GND (FIXED)

Row A		Row B		Row C		Row D	
Pin	Name	Pin	Name	Pin	Name	Pin	Name
A81	LVDS_A_CK+	B81	LVDS_B_CK+	C81	PEG_RX9+	D81	PEG_TX9+
A82	LVDS_A_CK-	B82	LVDS_B_CK-	C82	PEG_RX9-	D82	PEG_TX9-
A83	LVDS_I2C_CK	B83	LVDS_BKLT_CTRL	C83	TPM_PP	D83	RSVD
A84	LVDS_I2C_DAT	B84	VCC_5V_SBY	C84	GND	D84	GND
A85	GPI3	B85	VCC_5V_SBY	C85	PEG_RX10+	D85	PEG_TX10+
A86	RSVD	B86	VCC_5V_SBY	C86	PEG_RX10-	D86	PEG_TX10-
A87	RSVD	B87	VCC_5V_SBY	C87	GND	D87	GND
A88	PCIE0_CK_REF+	B88	BIOS_DIS1#	C88	PEG_RX11+	D88	PEG_TX11+
A89	PCIE0_CK_REF-	B89	VGA_RED	C89	PEG_RX11-	D89	PEG_TX11-
A90	GND (FIXED)	B90	GND (FIXED)	C90	GND (FIXED)	D90	GND (FIXED)
A91	SPI_POWER	B91	VGA_GRN	C91	PEG_RX12+	D91	PEG_TX12+
A92	SPI_MISO	B92	VGA_BLU	C92	PEG_RX12-	D92	PEG_TX12-
A93	GPO0	B93	VGA_HSYNC	C93	GND	D93	GND
A94	SPI_CLK	B94	VGA_VSYNC	C94	PEG_RX13+	D94	PEG_TX13+
A95	SPI_MOSI	B95	VGA_I2C_CK	C95	PEG_RX13-	D95	PEG_TX13-
A96	TPM_PP	B96	VGA_I2C_DAT	C96	GND	D96	GND
A97	TYPE10#	B97	SPI_CS#	C97	RSVD	D97	RSVD
A98	SER0_TX	B98	RSVD	C98	PEG_RX14+	D98	PEG_TX14+
A99	SER0_RX	B99	RSVD	C99	PEG_RX14-	D99	PEG_TX14-
A100	GND (FIXED)	B100	GND (FIXED)	C100	GND (FIXED)	D100	GND (FIXED)
A101	SER1_TX	B101	FAN_PWMOUT	C101	PEG_RX15+	D101	PEG_TX15+
A102	SER1_RX	B102	FAN_TACHIN	C102	PEG_RX15-	D102	PEG_TX15-
A103	LID#	B103	SLEEP#	C103	GND	D103	GND
A104	VCC_12V	B104	VCC_12V	C104	VCC_12V	D104	VCC_12V
A105	VCC_12V	B105	VCC_12V	C105	VCC_12V	D105	VCC_12V
A106	VCC_12V	B106	VCC_12V	C106	VCC_12V	D106	VCC_12V
A107	VCC_12V	B107	VCC_12V	C107	VCC_12V	D107	VCC_12V
A108	VCC_12V	B108	VCC_12V	C108	VCC_12V	D108	VCC_12V
A109	VCC_12V	B109	VCC_12V	C109	VCC_12V	D109	VCC_12V
A110	GND (FIXED)	B110	GND (FIXED)	C110	GND (FIXED)	D110	GND (FIXED)

3.2 Signal Description Terminology

The following terms are used in the COM Express AB/CD Signal Descriptions below.

I	Input to the Module
O	Output from the Module
I/O	Bi-directional input / output signal
OD	Open drain output
I 3.3V	Input 3.3V tolerant
I 5V	Input 5V tolerant
O 3.3V	Output 3.3V signal level
O 5V	Output 5V signal level
I/O 3.3V	Bi-directional signal 3.3V tolerant
I/O 5V	Bi-directional signal 5V tolerant
I/O 3.3Vsb	Input 3.3V tolerant active in standby state
P	Power Input/Output
REF	Reference voltage output that may be sourced from a module power plane.
PDS	Pull-down strap. This is an output pin on the module that is either tied to GND or not connected. The signal is used to indicate the PICMG module type to the Carrier Board.
PU	ADLINK implemented pull-up resistor on module
PD	ADLINK implemented pull-down resistor on module

3.3 AB Signal Descriptions

3.3.1 Audio Signals

Signal	Pin #	Description	I/O	PU/PD	Comment
AC_RST# / HDA_RST#	A30	Reset output to codec, active low.	O 3.3VSB		VSB because PCH uses suspend power for RESET
AC_SYNC / HDA_SYNC	A29	Sample-synchronization signal to the codec(s).	O 3.3V		
AC_BITCLK / HDA_BITCLK	A32	Serial data clock generated by the external codec(s).	I/O 3.3V		
AC_SDOUT / HDA_SDOUT	A33	Serial TDM data output to the codec.	O 3.3V		
AC_SDIN[2:0] HDA_SDIN[2:0]	B28 B30	Serial TDM data inputs from up to 3 codecs.	I/O 3.3V		

3.3.2 Analog VGA

Signal	Pin #	Description	I/O	PU/PD	Comment
VGA_RED	B89	Red for monitor. Analog DAC output, designed to drive a 37.5-Ohm equivalent load.	O Analog		Not supported
VGA_GRN	B91	Green for monitor Analog DAC output, designed to drive a 37.5-Ohm equivalent load.	O Analog		Not supported
VGA_BLU	B92	Blue for monitor. Analog DAC output, designed to drive a 37.5-Ohm equivalent load.	O Analog		Not supported
VGA_HSYNC	B93	Horizontal sync output to VGA monitor	O 3.3V		Not supported
VGA_VSYNC	B94	Vertical sync output to VGA monitor	O 3.3V		Not supported
VGA_I2C_CK	B95	DDC clock line (I ² C port dedicated to identify VGA monitor capabilities)	I/O OD 3.3V		Not supported
VGA_I2C_DAT	B96	DDC data line.	I/O OD 3.3V		Not supported

3.3.3 LVDS

Signal	Pin #	Description	I/O	PU/PD	Comment
LVDS_A0+ LVDS_A0- LVDS_A1+ LVDS_A1- LVDS_A2+ LVDS_A2- LVDS_A3+ LVDS_A3-	A71 A72 A73 A74 A75 A76 A78 A79	LVDS Channel A differential pairs	O LVDS		
LVDS_A_CK+ LVDS_A_CK-	A81 A82	LVDS Channel A differential clock	O LVDS		
LVDS_B0+ LVDS_B0- LVDS_B1+ LVDS_B1- LVDS_B2+ LVDS_B2- LVDS_B3+ LVDS_B3-	B71 B72 B73 B74 B75 B76 B77 B78	LVDS Channel B differential pairs	O LVDS		
LVDS_B_CK+ LVDS_B_CK-	B81 B82	LVDS Channel B differential clock	O LVDS		
LVDS_VDD_EN	A77	LVDS panel power enable	O 3.3V		
LVDS_BKLT_EN	B79	LVDS panel backlight enable	O 3.3V		
LVDS_BKLT_CTRL	B83	LVDS panel backlight brightness control	O 3.3V	PD 100K	Realtek ePD to LVDS requirement
LVDS_I2C_CK	A83	DDC lines used for flat panel detection and control.	O 3.3V	PU 2k2 3.3V	
LVDS_I2C_DAT	A84	DDC lines used for flat panel detection and control.	I/O 3.3V	PU 2k2 3.3V	

3.3.4 Gigabit Ethernet

Gigabit Ethernet	Pin #	Description	I/O	PU/PD	Comment																				
GBE0_MDIO+ GBE0_MDIO- GBE0_MDI1+ GBE0_MDI1- GBE0_MDI2+ GBE0_MDI2- GBE0_MDI3+ GBE0_MDI3-	A13 A12 A10 A9 A7 A6 A3 A2	Gigabit Ethernet Controller 0: Media Dependent Interface Differential Pairs 0, 1, 2, 3. The MDI can operate in 1000, 100, and 10Mbit/sec modes. Some pairs are unused in some modes according to the following: <table border="1" style="margin-left: auto; margin-right: auto;"> <thead> <tr> <th></th> <th>1000BASE-T</th> <th>100BASE-TX</th> <th>10BASE-T</th> </tr> </thead> <tbody> <tr> <td>MDI[0]+/-</td> <td>B1_DA+/-</td> <td>TX+/-</td> <td>TX+/-</td> </tr> <tr> <td>MDI[1]+/-</td> <td>B1_DB+/-</td> <td>RX+/-</td> <td>RX+/-</td> </tr> <tr> <td>MDI[2]+/-</td> <td>B1_DC+/-</td> <td></td> <td></td> </tr> <tr> <td>MDI[3]+/-</td> <td>B1_DD+/-</td> <td></td> <td></td> </tr> </tbody> </table>		1000BASE-T	100BASE-TX	10BASE-T	MDI[0]+/-	B1_DA+/-	TX+/-	TX+/-	MDI[1]+/-	B1_DB+/-	RX+/-	RX+/-	MDI[2]+/-	B1_DC+/-			MDI[3]+/-	B1_DD+/-			I/O Analog		Twisted pair signals for external transformer.
	1000BASE-T	100BASE-TX	10BASE-T																						
MDI[0]+/-	B1_DA+/-	TX+/-	TX+/-																						
MDI[1]+/-	B1_DB+/-	RX+/-	RX+/-																						
MDI[2]+/-	B1_DC+/-																								
MDI[3]+/-	B1_DD+/-																								
GBE0_ACT#	B2	Gigabit Ethernet Controller 0 activity indicator, active low.	O 3.3VSB	PU 10k 3.3VSB																					
GBE0_LINK#	A8	Gigabit Ethernet Controller 0 link indicator, active low.	O 3.3VSB																						
GBE0_LINK100#	A4	Gigabit Ethernet Controller 0 100Mbit/sec link indicator, active low.	O 3.3VSB																						
GBE0_LINK1000#	A5	Gigabit Ethernet Controller 0 1000Mbit/sec link indicator, active low.	O 3.3VSB																						
GBE0_CTREF	A14	Reference voltage for Carrier Board Ethernet channel 1 and 2 magnetics center tap. The reference voltage is determined by the requirements of the Module PHY and may be as low as 0V and as high as 3.3V. The reference voltage output shall be current limited on the Module. In the case in which the reference is shorted to ground, the current shall be 250 mA or less.	GND min 3.3V max																						

3.3.5 Serial ATA

Signal	Pin #	Description	I/O	PU/PD	Comment
SATA0_TX+ SATA0_TX-	A16 A17	Serial ATA channel 0, Transmit Output differential pair.	O SATA		AC coupled on Module
SATA0_RX+ SATA0_RX-	A19 A20	Serial ATA channel 0, Receive Input differential pair.	I SATA		AC coupled on Module
SATA1_TX+ SATA1_TX-	B16 B17	Serial ATA channel 1, Transmit Output differential pair.	O SATA		AC coupled on Module
SATA1_RX+ SATA1_RX-	B19 B20	Serial ATA channel 1, Receive Input differential pair.	I SATA		AC coupled on Module
SATA2_TX+ SATA2_TX-	A22 A23	Serial ATA channel 2, Transmit Output differential pair.	O SATA		AC coupled on Module
SATA2_RX+ SATA2_RX-	A25 A26	Serial ATA channel 2, Receive Input differential pair.	I SATA		AC coupled on Module
SATA3_TX+ SATA3_TX-	B22 B23	Serial ATA channel 3, Transmit Output differential pair.	O SATA		AC coupled on Module
SATA3_RX+ SATA3_RX-	B25 B26	Serial ATA channel 3, Receive Input differential pair.	I SATA		AC coupled on Module
(S)ATA_ACT#	A28	ATA (parallel and serial) or SAS activity indicator, active low.	O 3.3V		

3.3.6 PCI Express

Signal	Pin #	Description	I/O	PU/PD	Comment
PCIE_TX0+ PCIE_TX0-	A68 A69	PCI Express channel 0, Transmit Output differential pair.	O PCIE		AC coupled on Module
PCIE_RX0+ PCIE_RX0-	B68 B69	PCI Express channel 0, Receive Input differential pair.	I PCIE		AC coupled off Module
PCIE_TX1+ PCIE_TX1-	A64 A65	PCI Express channel 1, Transmit Output differential pair.	O PCIE		AC coupled on Module
PCIE_RX1+ PCIE_RX1-	B64 B65	PCI Express channel 1, Receive Input differential pair.	I PCIE		AC coupled off Module
PCIE_TX2+ PCIE_TX2-	A61 A62	PCI Express channel 2, Transmit Output differential pair.	O PCIE		AC coupled on Module
PCIE_RX2+ PCIE_RX2-	B61 B62	PCI Express channel 2, Receive Input differential pair.	I PCIE		AC coupled off Module
PCIE_TX3+ PCIE_TX3-	A58 A59	PCI Express channel 3, Transmit Output differential pair.	O PCIE		AC coupled on Module
PCIE_RX3+ PCIE_RX3-	B58 B59	PCI Express channel 3, Receive Input differential pair.	I PCIE		AC coupled off Module
PCIE_TX4+ PCIE_TX4-	A55 A56	PCI Express channel 4, Transmit Output differential pair.	O PCIE		Connected to LAN
PCIE_RX4+ PCIE_RX4-	B55 B56	PCI Express channel 4, Receive Input differential pair.	I PCIE		Connected to LAN
PCIE_TX5+ PCIE_TX5-	A52 A53	PCI Express channel 5, Transmit Output differential pair.	O PCIE		Not supported
PCIE_RX5+ PCIE_RX5-	B52 B53	PCI Express channel 5, Receive Input differential pair.	I PCIE		Not supported
PCIE_CLK_REF+ PCIE_CLK_REF-	A88 A89	PCI Express Reference Clock output for all PCI Express and PCI Express Graphics Lanes.	O PCIE		

3.3.7 Express Card

Signal	Pin #	Description	I/O	PU/PD	Comment
EXCD0_CPPE# EXCD1_CPPE#	A49 B48	PCI ExpressCard: PCI Express capable card request	I 3.3V	PU 10k 3.3V	
EXCD0_PERST# EXCD1_PERST#	A48 B47	PCI ExpressCard: reset	O 3.3V		

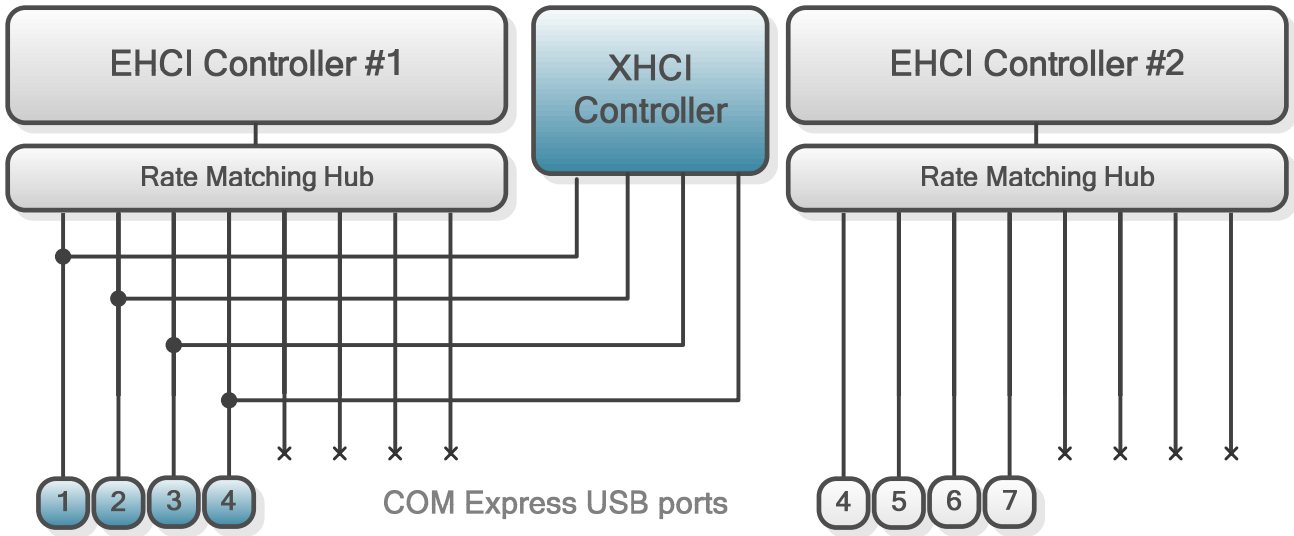
3.3.8 LPC Bus

Signal	Pin #	Description	I/O	PU/PD	Comment
LPC_AD[0:3]	B4-B7	LPC multiplexed address, command and data bus	I/O 3.3V		
LPC_FRAME#	B3	LPC frame indicates the start of an LPC cycle	O 3.3V		
LPC_DRQ0# LPC_DRQ1#	B8 B9	LPC serial DMA request	I 3.3V		
LPC_SERIRQ	A50	LPC serial interrupt	I/O OD 3.3V	PU 8k2 3.3V	
LPC_CLK	B10	LPC clock output - 33MHz nominal	O 3.3V		

3.3.9 USB

Signal	Pin #	Description	I/O	PU/PD	Comment
USB0+ USB0-	A46 A45	USB differential data pairs for Port 0	I/O 3.3VSB		USB 1.1/ 2.0 compliant
USB1+ USB1-	B46 B45	USB differential data pairs for Port 1	I/O 3.3VSB		USB 1.1/ 2.0 compliant
USB2+ USB2-	A43 A42	USB differential data pairs for Port 1	I/O 3.3VSB		USB 1.1/ 2.0 compliant
USB3+ USB3-	B43 B42	USB differential data pairs for Port 2	I/O 3.3VSB		USB 1.1/ 2.0 compliant
USB4+ USB4-	A40 A39	USB differential data pairs for Port 3	I/O 3.3VSB		USB 1.1/ 2.0 compliant
USB5+ USB5-	B40 B39	USB differential data pairs for Port 4	I/O 3.3VSB		USB 1.1/ 2.0 compliant
USB6+ USB6-	A37 A36	USB differential data pairs for Port 5	I/O 3.3VSB		USB 1.1/ 2.0 compliant
USB7+ USB7-	B37 B37	USB differential data pairs for Port 6	I/O 3.3VSB		USB 1.1/ 2.0 compliant
USB_0_1_OC#	B44	USB over-current sense, USB ports 0 and 1. A pull-up for this line shall be present on the module. An open drain driver from a USB current monitor on the carrier board may drive this line low.	I 3.3VSB	PU 10k 3.3VSB	Do not pull high on carrier
USB_2_3_OC#	A44	USB over-current sense, USB ports 2 and 3. A pull-up for this line shall be present on the module. An open drain driver from a USB current monitor on the carrier board may drive this line low. .	I 3.3VSB	PU 10k 3.3VSB	Do not pull high on carrier
USB_4_5_OC#	B38	USB over-current sense, USB ports 4 and 5. A pull-up for this line shall be present on the module. An open drain driver from a USB current monitor on the carrier board may drive this line low.	I 3.3VSB	PU 10k 3.3VSB	Do not pull high on carrier
USB_6_7_OC#	A38	USB over-current sense, USB ports 6 and 7. A pull-up for this line shall be present on the module. An open drain driver from a USB current monitor on the carrier board may drive this line low.	I 3.3VSB	PU 10k 3.3VSB	Do not pull high on carrier

3.3.10 USB Root Segmentation



3.3.11 SPI (BIOS only)

Signal	Pin #	Description	I/O	PU/PD	Comment
SPI_CS#	B97	Chip select for Carrier Board SPI BIOS Flash.	O 3.3VSB		
SPI_MISO	A92	Data in to module from carrier board SPI BIOS flash.	I 3.3VSB		
SPI_MOSI	A95	Data out from module to carrier board SPI BIOS flash.	O 3.3VSB		
SPI_CLK	A94	Clock from module to carrier board SPI BIOS flash.	O 3.3VSB		
SPI_POWER	A91	Power supply for Carrier Board SPI – sourced from Module – nominally 3.3V. The Module shall provide a minimum of 100mA on SPI_POWER. Carriers shall use less than 100mA of SPL_POWER. SPI_POWER shall only be used to power SPI devices on the Carrier	O P 3.3VSB		
BIOS_DIS0#	A34	Selection strap to determine the BIOS boot device.	I	PU 10K 3.3V	Carrier shall pull to GND or leave no- connect.
BIOS_DIS1#	B88	Selection strap to determine the BIOS boot device.	I	PU 10K 3.3V	Carrier shall pull to GND or leave no- connect

3.3.12 Miscellaneous

Signal	Pin #	Description	I/O	PU/PD	Comment
SPKR	B32	Output for audio enunciator, the “speaker” in PC-AT systems	O 3.3V		
WDT	B27	Output indicating that a watchdog time-out event has occurred.	O 3.3V		
THRM#	B35	Input from off-module temp sensor indicating an over-temp situation.	I 3.3V		
THERMTRIP#	A35	Active low output indicating that the CPU has entered thermal shutdown.	O 3.3V	PU 330 3.3V	
FAN_PWMOUT	B101	Fan speed control. Uses the Pulse Width Modulation (PWM) technique to control the fan's RPM.	O OD 3.3V		
FAN_TACHIN11	B102	Fan tachometer input for a fan with a two pulse output.	I OD 3.3V	PU 10k 3.3V	
TPM_PP11	C83	Trusted Platform Module (TPM) Physical Presence pin. Active high. TPM chip has an internal pull down. This signal is used to indicate Physical Presence to the TPM.	I 3.3V	PD 10k 3.3V	PD is only placed when TPM is installed on module

3.3.13 SMBus

Signal	Pin #	Description	I/O	PU/PD	Comment
SMB_CK	B13	System Management Bus bidirectional clock line. Power sourced through 5V standby rail and main power rails.	I/O OD 3.3VSB	PU 2k2 3.3VSB	
SMB_DAT#	B14	System Management Bus bidirectional data line. Power sourced through 5V standby rail and main power rails.	I/O OD 3.3VSB	PU 2k2 3.3VSB	
SMB_ALERT#	B15	System Management Bus Alert – active low input can be used to generate an SMI# (System Management Interrupt) or to wake the system. Power sourced through 5V standby rail and main power rails.	I 3.3VSB	PU 10k 3.3VSB	

3.3.14 I2C Bus

Signal	Pin #	Description	I/O	PU/PD	Comment
I2C_CK	B33	General purpose I ² C port clock output/input	I/O OD 3.3VSB	PU 2k2 3.3VSB	
I2C_DAT	B34	General purpose I ² C port data I/O line	I/O OD 3.3VSB	PU 2k2 3.3VSB	

3.3.15 General Purpose I/O (GPIO)

Signal	Pin #	Description	I/O	PU/PD	Comment
GPO[0]	A93	General purpose output pins.	O 3.3V		After hardware RESET output low
GPO[1]	B54	General purpose output pins.	O 3.3V		After hardware RESET output low
GPO[2]	B57	General purpose output pins.	O 3.3V		After hardware RESET output low
GPO[3]	B63	General purpose output pins.	O 3.3V		After hardware RESET output low
GPI[0]	A54	General purpose input pins. Pulled high internally on the module.	I 3.3V	PU 10K 3.3V	
GPI[1]	A63	General purpose input pins. Pulled high internally on the module.	I 3.3V	PU 10K 3.3V	
GPI[2]	A67	General purpose input pins. Pulled high internally on the module.	I 3.3V	PU 10K 3.3V	
GPI[3]	A85	General purpose input pins. Pulled high internally on the module.	I 3.3V	PU 10K 3.3V	

3.3.16 Serial Interface Signals

Signal	Pin #	Description	I/O	PU/PD	Comment
SER0_TX	A98	General purpose serial port transmitter (TTL level output)	O CMOS		Power rail tolerance 5V / 12V
SER0_RX	A99	General purpose serial port receiver (TTL level input)	I CMOS		Power rail tolerance 5V / 12V
SER1_TX	A101	General purpose serial port transmitter (TTL level output)	O CMOS		Power rail tolerance 5V / 12V
SER1_RX	A102	General purpose serial port receiver (TTL level input)	I CMOS		Power rail tolerance 5V / 12V

3.3.17 Power And System Management

Signal	Pin #	Description	I/O	PU/PD	Comment
PWRBTN#	B12	Power button to bring system out of S5 (soft off), active on falling edge.	I 3.3VSB	PU 10k 3.3VSB	
SYS_RESET#	B49	Reset button input. Active low request for module to reset and reboot. May be falling edge sensitive. For situations when SYS_RESET# is not able to reestablish control of the system, PWR_OK or a power cycle may be used.	I 3.3VSB	PU 10k 3.3VSB	
CB_RESET#	B50	Reset output from module to Carrier Board. Active low. Issued by module chipset and may result from a low SYS_RESET# input, a low PWR_OK input, a VCC_12V power input that falls below the minimum specification, a watchdog timeout, or may be initiated by the module software.	O 3.3VSB		
PWR_OK	B24	Power OK from main power supply. A high value indicates that the power is good. This signal can be used to hold off Module startup to allow carrier based FPGAs or other configurable devices time to be programmed.	I 3.3V	PU 100k 3.3VSB	
SUS_STAT#	B18	Indicates imminent suspend operation; used to notify LPC devices.	O 3.3VSB		
SUS_S3#	A15	Indicates system is in Suspend to RAM state. Active-low output. An inverted copy of SUS_S3# on the carrier board (also known as "PS_ON") may be used to enable the non-standby power on a typical ATX power supply.	O 3.3VSB		
SUS_S4#	A18	Indicates system is in Suspend to Disk state. Active low output.	O 3.3VSB		
SUS_S5#	A24	Indicates system is in Soft Off state.	O 3.3VSB		
WAKE0#	B66	PCI Express wake up signal.	I 3.3VSB	PU 10k 3.3VSB	
WAKE1#	B67	General purpose wake up signal. May be used to implement wake-up on PS/2 keyboard or mouse activity.	I 3.3VSB	PU 10k 3.3VSB	
BATLOW#	A27	Battery low input. This signal may be driven low by external circuitry to signal that the system battery is low, or may be used to signal some other external power-management event.	I 3.3VSB	PU 10k 3.3VSB	
LID#		LID button. Low active signal used by the ACPI operating system for a LID switch.	I OD 3.3VSB	PU 10k 3.3VSB	
SLEEP#		Sleep button. Low active signal used by the ACPI operating system to bring the system to sleep state or to wake it up again.	I OD 3.3VSB	PU 10K 3.3VSB	

3.3.18 Power and Ground

Signal	Pin #	Description	I/O	PU/PD	Comment
VCC_12V	A104-A109 B104-B109	Primary power input: +12V nominal (5 ~ 20V wide input). All available VCC_12V pins on the connector(s) shall be used.	P		5~20 V
VCC_5V_SBY	B84-B87	Standby power input: +5.0V nominal. If VCC5_SBY is used, all available VCC_5V_SBY pins on the connector(s) shall be used. Only used for standby and suspend functions. May be left unconnected if these functions are not used in the system design.	P		5Vsb ±5%
VCC_RTC	A47	Real-time clock circuit-power input. Nominally +3.0V.	P		
GND	A1, A11, A21, A31, A41, A51, A57, A66, A80, A90, A96, A100, A110, B1, B11, B21, B31, B41, B51, B60, B70, B80, B90, B100, B110	Ground - DC power and signal and AC signal return path.	P		

3.4 CD Signal Descriptions

3.4.1 USB 3.0 extension

Signal	Pin	Description	I/O	PU/PD	Comment
USB_SSRX0- USB_SSRX0+	C3 C4	Additional Receive signal differential pairs for the SuperSpeed USB data path on USB0	I PCIE		
USB_SSTX0- USB_SSTX0+	D3 D4	Additional Transmit signal differential pairs for the SuperSpeed USB data path on USB0	O PCIE		AC coupled on Module
USB_SSRX1- USB_SSRX1+	C6 C7	Additional Receive signal differential pairs for the SuperSpeed USB data path on USB1	I PCIE		
USB_SSTX1- USB_SSTX1+	D6 D7	Additional Transmit signal differential pairs for the SuperSpeed USB data path on USB1	O PCIE		AC coupled on Module
USB_SSRX2- USB_SSRX2+	C9 C10	Additional Receive signal differential pairs for the SuperSpeed USB data path on USB2	I PCIE		Not supported
USB_SSTX2- USB_SSTX2+	D9 D10	Additional Transmit signal differential pairs for the SuperSpeed USB data path on USB2	O PCIE		Not supported
USB_SSRX3- USB_SSRX3+	C12 C13	Additional Receive signal differential pairs for the SuperSpeed USB data path on USB3	I PCIE		Not supported
USB_SSTX3- USB_SSTX3+	D12 D13	Additional Transmit signal differential pairs for the SuperSpeed USB data path on USB3	O PCIE		Not supported

3.4.2 PCI Express x1

Signal	Pin #	Description	I/O	PU/PD	Comment
PCIE_TX6+ PCIE_TX6-	D19 D20	PCI Express channel 6, Transmit Output differential pair.	O PCIE		Not supported
PCIE_RX6+ PCIE_RX6-	C19 C20	PCI Express channel 6, Receive Input differential pair.	I PCIE		Not supported
PCIE_TX7+ PCIE_TX7-	D22 D23	PCI Express channel 7, Transmit Output differential pair.	O PCIE		Not supported
PCIE_RX7+ PCIE_RX7-	C22 C23	PCI Express channel 7, Receive Input differential pair.	I PCIE		Not supported

3.4.3 DDI Channels

DDI 1

Signal	Pin	Description	I/O	PU/PD	Comment	
DDI1_PAIR0+	D26	Digital Display Interface1 differential pairs	O PCIE			
DDI1_PAIR0-	D27					
DDI1_PAIR1+	D29					
DDI1_PAIR1-	D30					
DDI1_PAIR2+	D32					
DDI1_PAIR2-	D33					
DDI1_PAIR3+	D36					
DDI1_PAIR3-	D37					
DDI1_PAIR4+	C25					Pair 4 to Pair 6 Not supported
DDI1_PAIR4-	C26					
DDI1_PAIR5+	C29					
DDI1_PAIR5-	C30					
DDI1_PAIR6+	C15					
DDI1_PAIR6-	C16					
DDI1_HPD	C24	Digital Display Interface Hot-Plug Detect	I PCIE			
DDI1_CTRLCLK_AUX+	D15	IF DDI1_DDC_AUX_SEL is floating	I/O PCIe		DP1_AUX+	
		IF DDI1_DDC_AUX_SEL pulled high	I/O OD 3.3V		HDMI1_CTRLCLK	
DDI1_CTRLCLK_AUX-	D16	IF DDI1_DDC_AUX_SEL is floating	I/O PCIe		DP1_AUX+	
		IF DDI1_DDC_AUX_SEL pulled high	I/O OD 3.3V		HDMI1_CTRLDATA	
DDI1_DDC_AUX_SEL	D34	Selects the function of DDI1_CTRLCLK_AUX+ and DDI1_CTRLDATA_AUX-. This pin shall have a 1M pull-down to logic ground on the Module. If this input is floating the AUX pair is used for the DP AUX+/- signals. If pulled-high the AUX pair contains the CTRLCLK and CTRLDATA signals.	I/O OD 3.3V	PD 1M		

DDI 2

Signal	Pin	Description	I/O	PU/PD	Comment
DDI2_PAIR0+	D39	Digital Display Interface2 differential pairs			
DDI2_PAIR0-	D40				
DDI2_PAIR1+	D42				
DDI2_PAIR1-	D43				
DDI2_PAIR2+	D46				
DDI2_PAIR2-	D47				
DDI2_PAIR3+	D49				
DDI2_PAIR3-	D50				
DDI2_HPD	D44				
DDI2_CTRLCLK_AUX+	C32	IF DDI2_DDC_AUX_SEL is floating	I/O PCIe		DP2_AUX+
		IF DDI2_DDC_AUX_SEL pulled high	I/O OD 3.3V		HDMI2_CTRLCLK
DDI2_CTRLCLK_AUX-	C33	IF DDI2_DDC_AUX_SEL is floating	I/O PCIe		DP2_AUX+
		IF DDI2_DDC_AUX_SEL pulled high	I/O OD 3.3V		HDMI2_CTRLDATA
DDI2_DDC_AUX_SEL	C34	Selects the function of DDI2_CTRLCLK_AUX+ and DDI2_CTRLDATA_AUX-. This pin shall have a 1M pull-down to logic ground on the Module. If this input is floating the AUX pair is used for the DP AUX+/- signals. If pulled-high the AUX pair contains the CTRLCLK and CTRLDATA signals.		PD 1M	

DDI 3

Signal	Pin	Description	I/O	PU/PD	Comment
DDI3_PAIR0+	C39	Digital Display Interface3 differential pairs			Not supported
DDI3_PAIR0-	C40				
DDI3_PAIR1+	C42				
DDI3_PAIR1-	C43				
DDI3_PAIR2+	C46				
DDI3_PAIR2-	C47				
DDI3_PAIR3+	C49				
DDI3_PAIR3-	C50				
DDI3_HPD	C44				Not supported
DDI3_CTRLCLK_AUX+	C36	IF DDI3_DDC_AUX_SEL is floating	I/O PCIe		Not supported
		IF DDI3_DDC_AUX_SEL pulled high	I/O OD 3.3V		Not supported
DDI3_CTRLCLK_AUX-	C37	IF DDI3_DDC_AUX_SEL is floating	I/O PCIe		Not supported
		IF DDI3_DDC_AUX_SEL pulled high	I/O OD 3.3V		Not supported
DDI3_DDC_AUX_SEL	C38	Selects the function of DDI3_CTRLCLK_AUX+ and DDI3_CTRLDATA_AUX-. This pin shall have a 1M pull-down to logic ground on the Module. If this input is floating the AUX pair is used for the DP AUX+/- signals. If pulled-high the AUX pair contains the CTRLCLK and CTRLDATA signals.		PD 1M	Not supported

3.4.4 DDI to DP/HDMI/SDVO Mapping

Pin	Pin Name	DP	HDMI \ DVI
D26	DDI1_PAIR0+	DP1_LANE0+	TMDS1_DATA2+
D27	DDI1_PAIR0-	DP1_LANE0-	TMDS1_DATA2-
D29	DDI1_PAIR1+	DP1_LANE1+	TMDS1_DATA1+
D30	DDI1_PAIR1-	DP1_LANE1-	TMDS1_DATA1-
D32	DDI1_PAIR2+	DP1_LANE2+	TMDS1_DATA0+
D33	DDI1_PAIR2-	DP1_LANE2-	TMDS1_DATA0-
D36	DDI1_PAIR3+	DP1_LANE3+	TMDS1_CLK+
D37	DDI1_PAIR3-	DP1_LANE3-	TMDS1_CLK-
C25	DDI1_PAIR4+	Not supported	Not supported
C26	DDI1_PAIR4-	Not supported	Not supported
C29	DDI1_PAIR5+	Not supported	Not supported
C30	DDI1_PAIR5-	Not supported	Not supported
C15	DDI1_PAIR6+	Not supported	Not supported
C16	DDI1_PAIR6-	Not supported	Not supported
C24	DDI1_HPD	DP1_HPD	HDMI1_HPD
D15	DDI1_CTRLCLK_AUX+	DP1_AUX+	HMDI1_CTRLCLK
D16	DDI1_CTRLDATA_AUX-	DP1_AUX-	HMDI1_CTRLDATA
D34	DDI1_DDC_AUX_SEL		
D39	DDI2_PAIR0+	DP2_LANE0+	TMDS2_DATA2+
D40	DDI2_PAIR0-	DP2_LANE0-	TMDS2_DATA2-
D42	DDI2_PAIR1+	DP2_LANE1+	TMDS2_DATA1+
D43	DDI2_PAIR1-	DP2_LANE1-	TMDS2_DATA1-
D46	DDI2_PAIR2+	DP2_LANE2+	TMDS2_DATA0+
D47	DDI2_PAIR2-	DP2_LANE2-	TMDS2_DATA0-
D49	DDI2_PAIR3+	DP2_LANE3+	TMDS2_CLK+
D50	DDI2_PAIR3-	DP2_LANE3-	TMDS2_CLK-
D44	DDI2_HPD	DP2_HPD	HDMI2_HPD
C32	DDI2_CTRLCLK_AUX+	DP2_AUX+	HDMI2_CTRLCLK
C33	DDI2_CTRLDATA_AUX-	DP2_AUX-	HDMI2_CTRLDATA
C34	DDI2_DDC_AUX_SEL		

3.4.5 PCI Express Graphics x16 (PEG)

Signal	Pin	Description	I/O	PU/PD	Comment
PEG_RX0+	C52	PCI Express Graphics transmit differential pairs.	I PCIE		Not supported
PEG_RX0-	C53				
PEG_RX1+	C55				
PEG_RX1-	C56				
PEG_RX2+	C58				
PEG_RX2-	C59				
PEG_RX3+	C61				
PEG_RX3-	C62				
PEG_RX4+	C65				
PEG_RX4-	C66				
PEG_RX5+	C68				
PEG_RX5-	C69				
PEG_RX6+	C71				
PEG_RX6-	C72				
PEG_RX7+	C74				
PEG_RX7-	C75				
PEG_RX8+	C78				
PEG_RX8-	C79				
PEG_RX9+	C81				
PEG_RX9-	C82				
PEG_RX10+	C85				
PEG_RX10-	C86				
PEG_RX11+	C88				
PEG_RX11-	C89				
PEG_RX12+	C91				
PEG_RX12-	C92				
PEG_RX13+	C94				
PEG_RX13-	C95				
PEG_RX14+	C98				
PEG_RX14-	C99				
PEG_RX15+	C101				
PEG_RX15-	C102				
PEG_TX0+	D52	PCI Express Graphics receive differential pairs.	O PCIE		Not supported
PEG_TX0-	D53				
PEG_TX1+	D55				
PEG_TX1-	D56				
PEG_TX2+	D58				
PEG_TX2-	D57				
PEG_TX3+	D61				
PEG_TX3-	D62				
PEG_TX4+	D65				
PEG_TX4-	D66				
PEG_TX5+	D68				
PEG_TX5-	D69				
PEG_TX6+	D71				
PEG_TX6-	D72				
PEG_TX7+	D74				
PEG_TX7-	D75				
PEG_TX8+	D78				
PEG_TX8-	D79				
PEG_TX9+	D81				
PEG_TX9-	D82				
PEG_TX10+	D85				
PEG_TX10-	D86				
PEG_TX11+	D88				
PEG_TX11-	D89				
PEG_TX12+	D91				
PEG_TX12-	D92				
PEG_TX13+	D94				
PEG_TX13-	D95				
PEG_TX14+	D98				
PEG_TX14-	D99				

Signal	Pin	Description	I/O	PU/PD	Comment
PEG_TX15+ PEG_TX15-	D101 D102				
PEG_LANE_RV#	D54	PCI Express Graphics lane reversal input strap. Pull low on the Carrier board to reverse lane order.	I 1.05V		Not supported

3.4.6 Module Type Definition

Signal	Pin #	Description	I/O	Comment																												
TYPE0# TYPE1# TYPE2#	C54 C57 D57	<p>The TYPE pins indicate to the Carrier Board the Pin-out Type that is implemented on the module. The pins are tied on the module to either ground (GND) or are no-connects (NC). For Pinout Type 1, these pins are don't care (X).</p> <table border="1"> <thead> <tr> <th>TYPE2#</th> <th>TYPE1#</th> <th>TYPE0#</th> <th></th> </tr> </thead> <tbody> <tr> <td>X</td> <td>X</td> <td>X</td> <td>Pinout Type 1</td> </tr> <tr> <td>NC</td> <td>NC</td> <td>NC</td> <td>Pinout Type 2</td> </tr> <tr> <td>NC</td> <td>NC</td> <td>GND</td> <td>Pinout Type 3 (no IDE)</td> </tr> <tr> <td>NC</td> <td>GND</td> <td>NC</td> <td>Pinout Type 4 (no PCI)</td> </tr> <tr> <td>NC</td> <td>GND</td> <td>GND</td> <td>Pinout Type 5 (no IDE, no PCI)</td> </tr> <tr> <td>GND</td> <td>NC</td> <td>NC</td> <td>Pinout Type 6 (no IDE, no PCI)</td> </tr> </tbody> </table> <p>The Carrier Board should implement combinatorial logic that monitors the module TYPE pins and keeps power off (e.g deactivates the ATX_ON signal for an ATX power supply) if an incompatible module pin-out type is detected. The Carrier Board logic may also implement a fault indicator such as an LED.</p>	TYPE2#	TYPE1#	TYPE0#		X	X	X	Pinout Type 1	NC	NC	NC	Pinout Type 2	NC	NC	GND	Pinout Type 3 (no IDE)	NC	GND	NC	Pinout Type 4 (no PCI)	NC	GND	GND	Pinout Type 5 (no IDE, no PCI)	GND	NC	NC	Pinout Type 6 (no IDE, no PCI)		Type 6
TYPE2#	TYPE1#	TYPE0#																														
X	X	X	Pinout Type 1																													
NC	NC	NC	Pinout Type 2																													
NC	NC	GND	Pinout Type 3 (no IDE)																													
NC	GND	NC	Pinout Type 4 (no PCI)																													
NC	GND	GND	Pinout Type 5 (no IDE, no PCI)																													
GND	NC	NC	Pinout Type 6 (no IDE, no PCI)																													

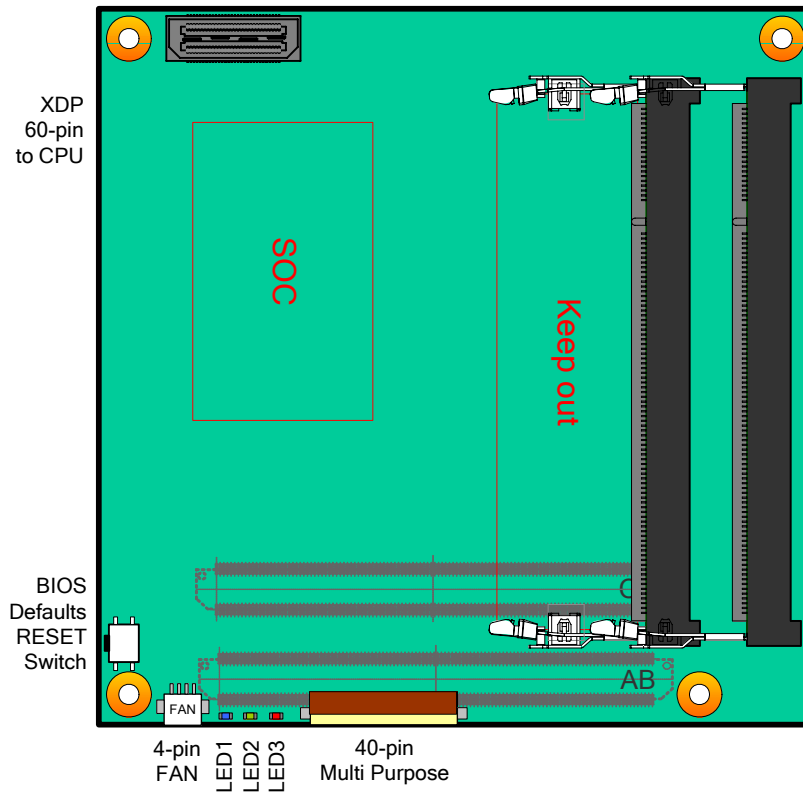
3.4.7 Power and Ground

Signal	Pin #	Description	I/O	PU/PD	Comment
VCC_12V	C104-C109 D104-D109	Primary power input: +12V nominal (5 ~ 20V wide input). All available VCC_12V pins on the connector(s) shall be used.	P		5~20 V
GND	C1, C11, C21, C31, C41, C51, C60, C70, C76, C80, C84, C87, C90, C93, C96, C100, C103, C110, D1, D11, D21, D31, D41, D51, D60, D67, D70, D76, D80, D84, D87, D90, D93, D96, D100, D103, D110	Ground - DC power and signal and AC signal return path. All available GND connector pins shall be used and tied to carrier board GND plane.	P		

4 Connector Pinouts on Module

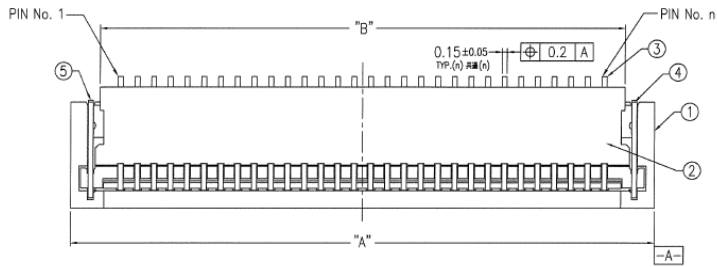
This chapter describes connectors and pinouts, LEDs and switches that are used on the module but are not included in the PICMG standard specification

- Connector and LED Locations

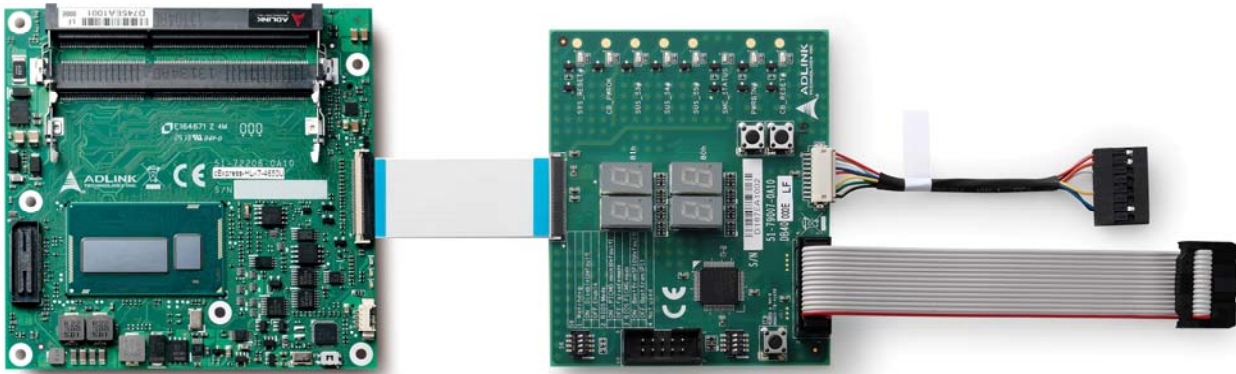


4.1 40-pin Debug Connector

- FPC Connector type: FCI 59GF Flex 10042867
- Pin orientation



- cExpress-HL and the DB40 debug module



➤ 40-pin Pin Description on the COM Express Module

Pin	Interface	Signal	Remark
1	SPI Program interface	VCC_SPI_IN	SPI Power Input from flash tool to module. HW need add MOS FET to switch SPI power for SPI ROM
2		GND	
3		SPI_BIOS_CS0#	
4		SPI_BIOS_CS1#	
5		SPI_BIOS_MISO	
6		SPI_BIOS_MOSI	
7		SPI_BIOS_CLK	
8	LPC Bus	3V3_LPC	System power 3.3V provide from COM module
9		GND	
10		BIOS_DIS0	
11		RST#	
12		CLK33_LPC	
13		LPC_FRAME#	
14		LPC_AD3	
15		LPC_AD2	
16		LPC_AD1	always power 3.3V provide from COM module
17		LPC_AD0	
18	BMC Program interface	3.3V_BMC	always power 3.3V provide from COM module
19		3.3V_BMC	always power 3.3V provide from COM module
20		GND	

Pin	Interface	Signal	Remark
21	BMC Program interface (continued)	TXD6	
22		RXD6	
23		FUMD0	
24		RESET_IN#	
25		DATA	
26		CLK	
27		OCD0A	Include a jumper to connect OCD0A via 1K0 pull-up to 3.3V_BMC
28		OCD0B	Include a jumper to connect OCD0A via 1K0 pull-up to 3.3V_BMC
29	Test points	PWRBTN#	
30		SYS_RESET#	
31		CB_RESET#	
32		CB_PWROK	
33		SUS_S3#	
34		SUS_S4#	
35		SUS_S5#	
36	BMC Debug signals	POSTWDT_DIS#	Connect to Jumper for Debug
37		SEL_BIOS	Connect to Jumper for Debug
38		BIOS_MODE	Connect to Jumper for Debug
39		BMC_STATUS	
40	Reserved		

Note: The pin description on the debug module is the inverse of that on the COM Express module.

4.2 Status LEDs

To facilitate easier maintenance, status LED's are mounted on the board.

➤ LED Descriptions

Name	Color	Connection	Function
LED1	Blue	BMC output	Power Sequence Status Code (BMC) Power Changes, RESET (see 5.1.4 Exception Codes below)
LED2	Green	Power Source 3Vcc	S0 LED ON S3/S4/S5 LED OFF ECO mode LED OFF
LED3	Red	BMC output and same signal as WDT (B27) on BiB connector	Module power up WD LED = LED OFF Watchdog counting WD LED = LED OFF Watchdog timed out WD LED = LED ON Watchdog RESET WD LED = LED ON Rebooted after WD RESET WD LED = LED ON Rebooted after PWRBTN WD LED = LED ON Rebooted after RESET BTN WD LED = LED OFF Note: only a RESET not initiated by the BMC can clear the WD LED (user action)

4.4 Fan Connector

- Connector Type: JVE 24W1125A-04M00
- Pin Assignment

Name	Signal	Description
1	BMC_FAN_OUT	FAN_PWMOUT
2	BMC_FAN_PWM_IN	FAN_TACHIN
3	GND	Ground
4	P5V_S	5V

4.5 BIOS Setup Defaults RESET Button

To perform a hardware reset of BIOS default settings, perform the following steps:

1. Shut down the system.
2. Press the BIOS Setup Defaults RESET Button continuously and boot up the system. You can release the button when the BIOS prompt screen appears
3. The BIOS prompt screen will display a confirmation that BIOS defaults have been reset and request that you reboot the system.



5 Smart Embedded Management Agent (SEMA)

The onboard microcontroller (BMC) implements power sequencing and Smart Embedded Management Agent (SEMA) functionality. The microcontroller communicates via the System Management Bus with the CPU/chipset. The following functions are implemented:

- Total operating hours counter counts the number of hours the module has been run in minutes.
- On-time minutes counter counts the seconds since last system start.
- Temperature monitoring of CPU and board temperature minimum and maximum temperature values of CPU and board are stored in flash.
- Power cycles counter
- Boot counter counts the number of boot attempts.
- Watchdog Timer (Type-II) Set / Reset / Disable Watchdog Timer. Features auto-reload at power-up.
- System Restart Cause Power loss / BIOS Fail / Watchdog / Internal Reset / External Reset
- Fail-safe BIOS support In case of a boot failure, hardware signals tells external logic to boot from fail-safe BIOS.
- Flash area 1kB Flash area for customer data
- 128 Bytes Protected Flash area Keys, IDs, etc. can be stored in a write- and clear-protectable region.
- Board Identify Vendor / Board / Serial number / Production Date
- Main-current & voltage monitors drawn current and main voltages

For a detailed description of SEMA features and functionality, please refer to **SEMA Technical Manual** and **SEMA Software Manual**, downloadable at: <http://www.adlinktech.com/sema/>.

5.1 Board Specific SEMA Functions

5.1.1 Voltages

The BMC of the cExpress-HL implements a voltage monitor and samples several onboard voltages. The voltages can be read by calling the SEMA function "Get Voltages". The function returns a 16-bit value divided into high-byte (MSB) and low-byte (LSB).

ADC Channel	Voltage Name	Voltage Formula [V]
0	+V1.05S	$(MSB_{<<8} + LSB) \times 3.3 / 1024$
1	+VCORE	$(MSB_{<<8} + LSB) \times 3.3 / 1024$
2	+V1.05S	$(MSB_{<<8} + LSB) \times 3.3 / 1024$
3	+V3.3A	$(MSB_{<<8} + LSB) \times 1.100 \times 3.3 / 1024$
4	+VDDQ (V1.35 ~ V1.5)	$(MSB_{<<8} + LSB) \times 3.3 / 1024$
5	+V5A_DUAL	$(MSB_{<<8} + LSB) \times 1.833 \times 3.3 / 1024$
6	+VIN	$(MSB_{<<8} + LSB) \times 6.000 \times 3.3 / 1024$
7	(MAIN CURRENT)	Use Main Current Function

5.1.2 Main Current

The BMC of the cExpress-HL implements a current monitor. The current can be read by calling the SEMA function "Get Main Current". The function returns four 16-bit values divided in high-byte (MSB) and low-byte (LSB). These 4 values represent the last 4 currents drawn by the board. The values are sampled every 250ms. The order of the 4 values is NOT in chronological order. Access by the BMC may increase the drawn current of the whole system. In this case, there are still 3 samples not influenced by the read access.

$$\text{Main Current} = (MSB_{n<<8} + LSB_n) \times 8.06\text{mA}$$

5.1.3 BMC Status

This register shows the status of BMC controlled signals on the cExpress-HL.

Status Bit	Signal
0	WDT_OUT
1	LVDS_VDDEN
2	LVDS_BKLTEN
3	BIOS_MODE
4	POSTWDT_DISn
5	SEL_BIOS
6	BIOS_DIS0n
7	BIOS_DIS1n

5.1.4 Exception Codes

In case of an error, the BMC drives a blinking code on the blue Status LED (LED1). The same error code is also reported by the BMC Flags register. The Exception Code is not stored in the Flash Storage and is cleared when the power is removed. Therefore, a "Clear Exception Code" command is not needed or supported.

Exception Code	Error Message
0	NOERROR
2	NO_SUSCLK
3	NO_SLP_S5
4	NO_SLP_S4
5	NO_SLP_S3
6	BIOS_FAIL
7	RESET_FAIL
8	POWER_FAIL
9	LOW_VIN
11	VCORE
12	+P1V05_S
13	+P3V3_A
14	+VDDQ
15	+P5V_A
16	+P12V
18	CRITICAL_TEMP
19	NO_CB_PWROK
20	NO_SYS_GD
21	NO_VCORE_GD
22	NO_XDP_PIN47

5.1.5 BMC Flags

The BMC Flags register returns the last detected Exception Code since power-up and shows the BIOS in use and the power mode.

Bit	Description
[0 ~ 4]	Exception Code
[6]	0 = AT mode 1 = ATX mode
[7]	0 = Standard BIOS 1 = Fail-safe BIOS.

6 System Resources

6.1 System Memory Map

Address Range (decimal)	Address Range (hex)	Size	Description
(4GB-2MB)	FFE00000 – FFFFFFFF	2 MB	High BIOS Area
(4GB-18MB) – (4GB-17MB-1)	FEE00000 – FEEFFFFFF	1 MB	MSI Interrupts
(4GB-20MB) – (4GB-19MB-1)	FEC00000 – FECFFFFFF	1 MB	APIC Configuration Space
1MB -15MB	100000 - EFFFFFF	14MB	Main Memory
0K -1MB	00000 – FFFFFFF	1MB	DOS Compatibility Memory

6.2 Direct Memory Access Channels

Channel Number	Data Width	System Resource
0	8-bits	Generic
1	8-bits	Generic
2	8-bits	Generic
3	8-bits	Generic
4		Reserved - cascade channel
5	16-bits	Generic
6	16-bits	Generic
7	16-bits	Generic

6.3 I/O Map

Hex Range	Device
000-01F	DMA controller 1, 8237A-5 equivalent
020-02D and 030-03F	Interrupt controller 1, 8259 equivalent
02E-02F	LPC SIO () configuration index/data registers
040-05F	Timer, 8254-2 equivalent
060, 062, 064, 066, 068-06F	8742 equivalent (keyboard)
061, 063, 065, 067	NMI control and status
070-07F	Real Time Clock Controller(bit 7 -NMI mask)
080-091	DMA page register
092	Reset (Bit 0)/ Fast Gate A20 (Bit 1)
93-9F	DMA page registers continued
0A0-0B1 and 0B4-0BF	Interrupt controller 2, 8259 equivalent
0B2 and 0B3	APM control and status port respectively
0C0-0DF	DMA controller 2, 8237A-5 equivalent
0E0-0EF	Available
0F0	Co-processor error register
0F1	N/A
0F2-0F3	N/A
0F4	IDE ID port
0F5-0F7	N/A
0F8	IDE Index port
0F9-0FB	N/A
0FC	IDE Data port
0FD-0FF	N/A
100-179	Available
180-181	Default AIM4 SRAM control register (May be remapped)
182-1EF	Available
1F0-1F7	Primary IDE Controller (AT Drive)
1FB-22F	Available
230 -23F	Available
240 -25F	Serial Port 3/4
260-2F7	Available
2F8-2FF	Serial Port 2
300-36F	Available
370-377	Alt. Floppy Disk Controller
378-37F	Available
380-3AF	Available
3B0-3BB and 3BF	Mono/VGA mode video

Hex Range	Device
3BC-3BE	Reserved for parallel port
3C0-3DF	VGA registers
3E0-3EF	Available
3F0-3F7	Available
3F8-3FF	Serial port 1
4D0	Master PIC Edge/Level Trigger register
4D1	Slave PIC Edge/Level Trigger register
CF8-CFB	PCI configuration address register (32 bit I/O only)
CF9	Reset Control register (8 bit I/O)
CFC-CFF	PCI configuration data register
F040	Smbus base address for SB.
1C00	GPIO Base Address for SB
1800	PM (ACPI) Base Address for SB
1860	Alias for ICH TCO base address.
0A00-0AFF	Reserved for SIO functions base address (ex: PME /GPIO etc)

6.4 Interrupt Request (IRQ) Lines

PIC Mode

IRQ#	Typical Interrupt Resource	Connected to Pin	Available
0	Counter 0	N/A	No
1	Keyboard controller	N/A	No
2	Cascade interrupt from slave PIC	N/A	No
3	Serial Port 2 (COM2)	IRQ3 via SERIRQ / PIRQ	Note (1)
4	Serial Port 1 (COM1)	IRQ4 via SERIRQ / PIRQ	Note (1)
5	Parallel Port 2 (LPT2)	IRQ5 via SERIRQ / PIRQ	Note (1)
6	Generic	IRQ6 via SERIRQ / PIRQ	No
7	Generic	IRQ7 via SERIRQ / PIRQ	Note (1)
8	Real-time clock	N/A	No
9	Generic	N/A	Note (1)
10	Serial Port 3 (COM3)	IRQ10 via SERIRQ / PIRQ	Note (1)
11	Serial Port 4 (COM4)	IRQ11 via SERIRQ / PIRQ	Note (1)
12	PS/2 Mouse	IRQ12 via SERIRQ / PIRQ	Note (1)
13	Math Processor	N/A	Note (1)
14	Primary IDE controller	IRQ14 via SERIRQ / PIRQ	Note (1)
15	Secondary IDE controller	IRQ15 via SERIRQ / PIRQ	Note (1)

Note (1): These IRQs can be used for PCI devices when onboard device is disabled.

APIC Mode

IRQ#	Typical Interrupt Resource	Connected to Pin	Available
0	Counter 0	N/A	No
1	Keyboard controller	N/A	No
2	Cascade interrupt from slave PIC	N/A	No
3	Serial Port 2 (COM2)	IRQ3 via SERIRQ / PIRQ	Note (1)
4	Serial Port 1 (COM1)	IRQ4 via SERIRQ / PIRQ	Note (1)
5	N/A	N/A	Note (1)
6	N/A	N/A	Note (1)
7	N/A	N/A	Note (1)
8	Real-time clock	N/A	No
9	N/A	IRQ9 via SERIRQ / PIRQ	Note (1)
10	Serial Port 3 (COM3)	IRQ10 via SERIRQ / PIRQ	Note (1)
11	Serial Port 4 (COM4)	IRQ11 via SERIRQ / PIRQ	Note (1)
12	PS/2 Mouse	IRQ12 via SERIRQ / PIRQ	Note (1)
13	Math Processor	N/A	Note (1)
14	Primary IDE controller	IRQ14 via SERIRQ / PIRQ	Note (1)
15	Secondary IDE controller	IRQ15 via SERIRQ / PIRQ	Note (1)

IRQ#	Typical Interruption Resource	Connected to Pin	Available
16	N/A	Intel HDA, PCIE Port 0/1/2/3 EHCI Controller #2 , I.G.D ,XHCI Controller	Note (1)
17	N/A	PCIE Port 0/1/2/3	Note (1)
18	N/A	PCIE Port 0/1/2/3 SMBus Controller,	Note (1)
19	N/A	PCIE Port 0/1/2/3	Note (1)
20	N/A	Gbe Controller	Note (1)
21	N/A		Note (1)
22	N/A	Intel HDA	Note (1)
23	N/A	EHCI Controller #1	Note (1)

Note (1): These IRQs can be used for PCI devices when onboard device is disabled.

6.5 PCI Configuration Space Map

Bus Number	Device Number	Function Number	Routing	Description
00h	00h	00h	N/A	Intel host Bridge
00h	02h	00h	Internal	Intel I.G.D
00h	03h	00h	Internal	HD Audio Device
00h	14h	00h	Internal	xHCI Controller
00h	16h	00h	Internal	Intel Management Engine Interfaxe #1
00h	19h	00h	Internal	Gigabit Ethernet Controller
00h	1Bh	00h	Internal	High Definition Audio controller
00h	1Ch	00h	Internal	Intel PCI Express Root port 1
00h	1Ch	01h	Internal	Intel PCI Express Root port 2
00h	1Ch	02h	Internal	Intel PCI Express Root port 3
00h	1Ch	03h	Internal	Intel PCI Express Root port 4
00h	1Dh	00h	Internal	Intel USB EHCI Controller #1
00h	1Fh	00h	N/A	Intel LPC Interface Bridge
00h	1Fh	02h	Internal	SATA Host Controller #1
00h	1Fh	03h	Internal	SMBus Controller

6.6 PCI Interrupt Routing Map

INT Line	Audio Controller	xHCI Controller	ME Controller #1	GbEt Controller	HDA Controller
Int0	INTA:16	INTA:16	INTA:16	INTE:20	INTG:22
Int1			INTD:19		
Int2			INTC:18		
Int3			INTB:17		

INT Line	PCIE port1	PCIE port 2	PCIE port 3	PCIE port 4	EHCI #1	LPC Controller	SATA Controller #1	SMBus Controller
Int0	INTA:16	INTB:17	INTC:18	INTD:19	INTH:23	INTF:21		
Int1	INTB:17	INTC:18	INTD:19	INTA:16		INTD:19	INTD:19	
Int2	INTC:18	INTD:19	INTA:16	INTB:17		INTC:18		INTC:18
Int3	INTD:19	INTA:16	INTB:17	INTC:18		INTA:16		

7 BIOS Setup

TBD

8 Mechanical Information

8.1 Board-to-Board Connectors

To allow for different stacking heights, the receptacles for COM Express carrier boards are available in two heights: 5 mm and 8 mm. When 5 mm receptacles are chosen, the carrier board should be free of components.

Tyco 3-1827253-6

Foxconn QT002206-2131-3H

- 220-pin board-to-board connector with 0.5mm for a stacking height of 5 mm.
- This connector can be used with 5 mm through-hole standoffs (SMT type).



Tyco 3-6318491-6

Foxconn QT002206-4141-3H

- 220-pin board-to-board connector with 0.5mm for a stacking height of 8 mm.
- This connector can be used with 8 mm through-hole standoffs (SMT type).



Common Specifications

- Current capacity: 0.5A per pin
- Rated voltage: 50 VAC
- Insulation resistance: 100M or greater @ 500 VDC
- Temperature rating: -40°C ~ 85°C
- UL certification (ECBT2.E28476)
- Copper alloy (contacts)
- Housing: thermo-plastic molded compound (L.C.P.)

8.2 Thermal Solution

8.2.1 Heat Spreaders

The function of the heat spreader is to ensure an identical mechanical profile for all COM Express modules. By using a heat spreader, the thermal solution that is built on top of the module is compatible with all COM Express modules.

8.2.2 Heat Sinks

A heat sink can be used as a thermal solution for a specific COM Express module and can have a fan or be fanless, depending on the thermal requirements.

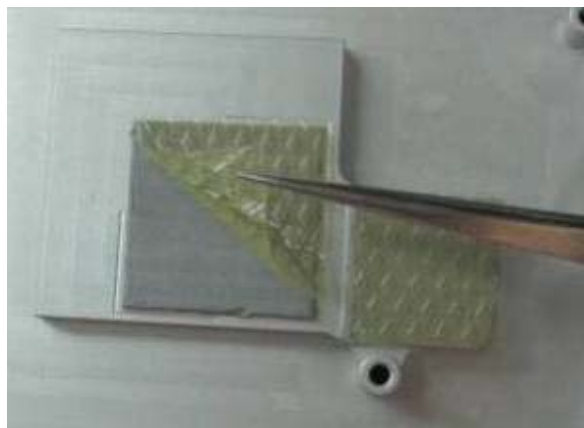
8.2.3 Installation

Install a heat spreader or heat sink using the following instructions.

Step 1: Before mounting the heatsink, install the required memory modules onto the SODIMM socket(s) on the COM Express module.

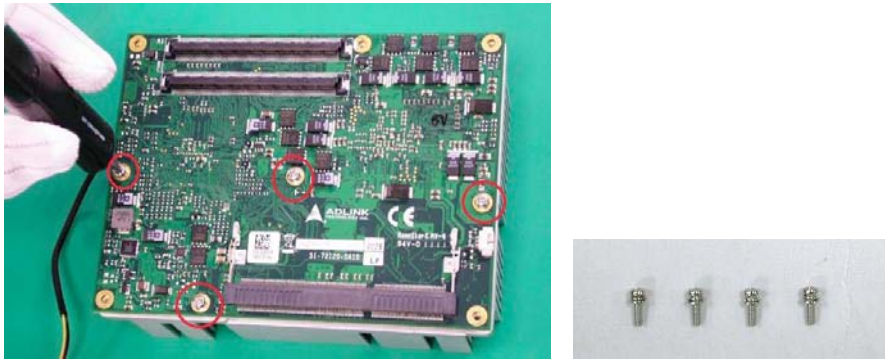


Step 2: Remove the protective membranes from the thermal pads.



Step 3: Assemble the heatsink onto the COM Express module.

Step 4: Use the four M2.5, L=6mm screws provided to fasten the heatsink to the module.

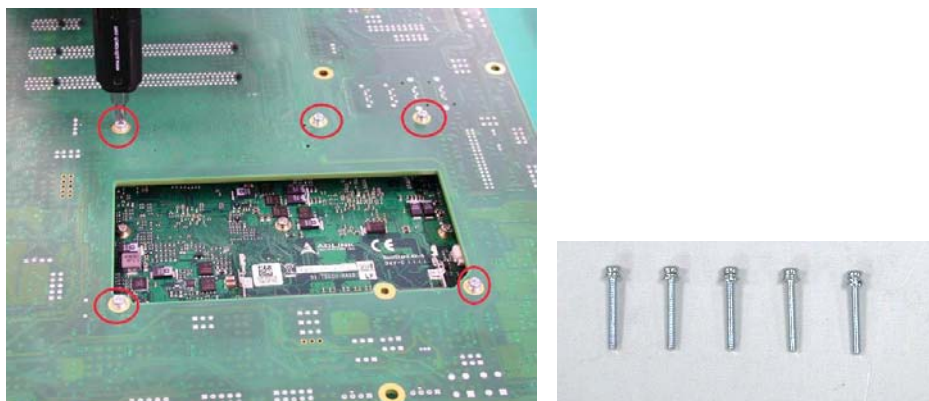


Step 5: Place the COM Express module and heatsink assembly onto the connectors on the carrier board as shown.



Then press down on the module until it is firmly seated on the carrier board.

Step 6: Use the five M2.5, L=16mm screws provided to secure the COM Express module to the carrier board from the solder side.

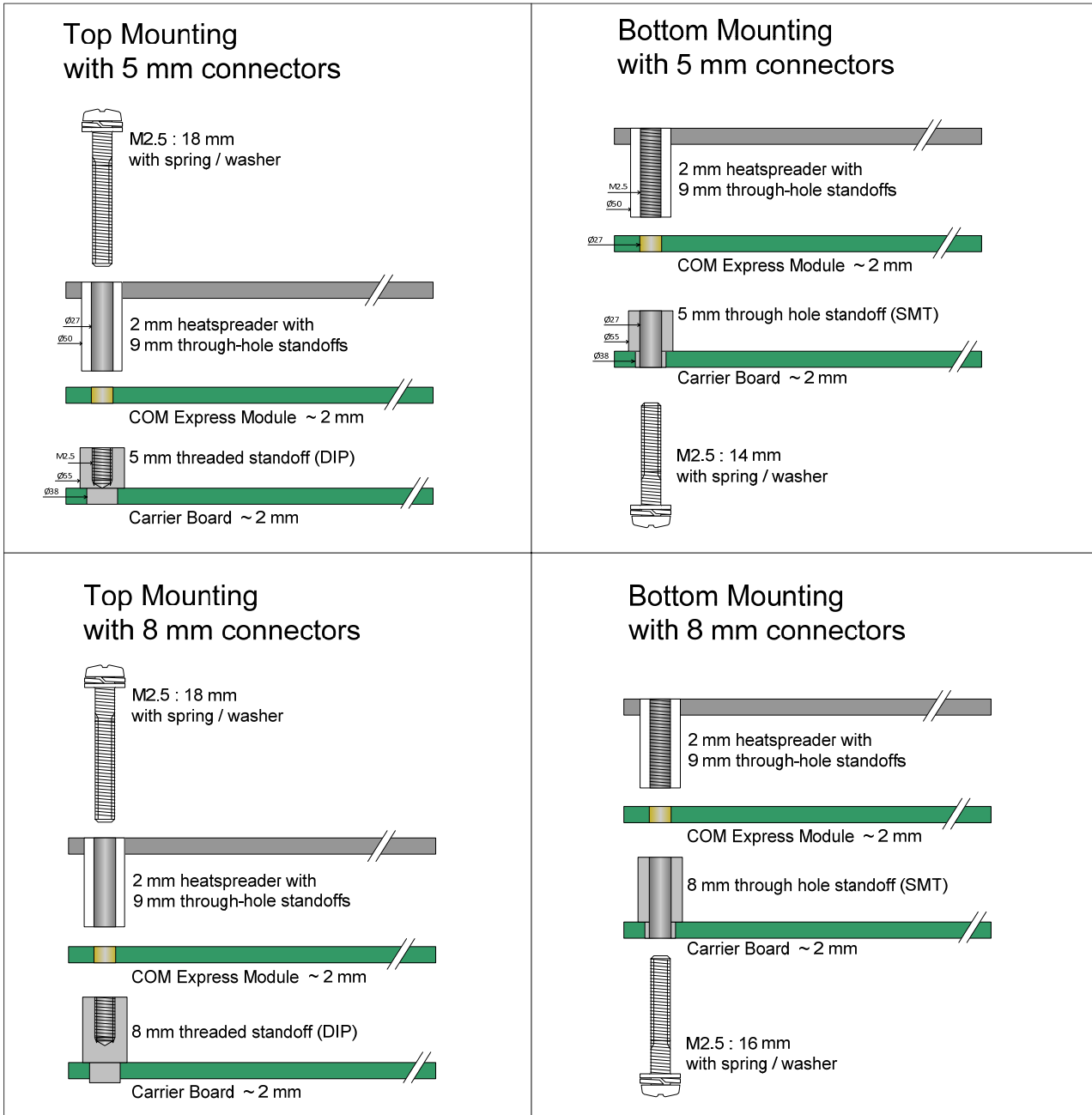


Step 7: If you are installing a heatsink with a fan, plug the fan connector into the carrier board as shown.



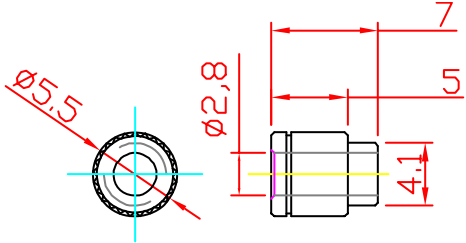
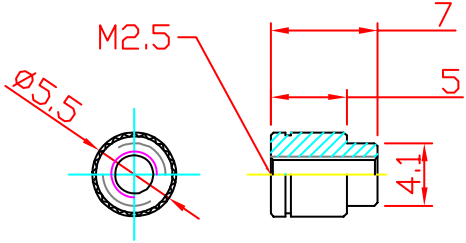
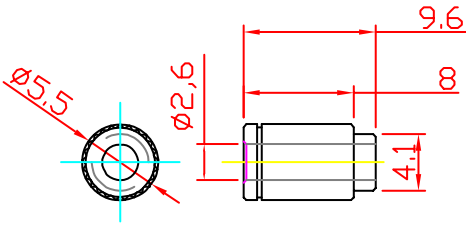
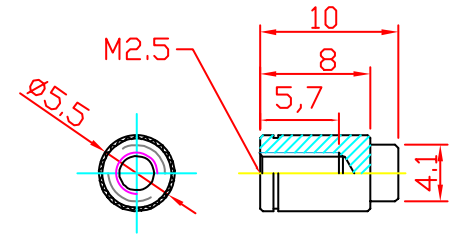
8.3 Mounting Methods

There are several standard ways to mount the COM Express module with a thermal solution onto a carrier board. In addition to the choice of 5 mm or 8mm board-to-board connectors, there is the choice of Top and Bottom mounting. In Top mounting, the threaded standoffs are on the carrier board and the thermal solution is equipped with through-hole standoffs. In Bottom mounting, the threaded standoffs are on the thermal solution and the carrier board has through-hole standoffs.



8.4 Standoff Types

The standoffs available for Top and Bottom mounting methods are shown below. Note that threaded standoffs are DIP type and through-hole standoffs are SMT type. Other types not listed are available upon request.

<p>5mm through-hole standoff (SMT type) P/N: 33-72000-0050</p> 	<p>5mm threaded standoff (DIP type) P/N: 33-72016-0050</p> 
<p>8mm through-hole standoff (SMT type) P/N: 33-72000-0080</p> 	<p>8mm threaded standoff (DIP type) P/N: 33-72015-0050</p> 

Safety Instructions

Read and follow all instructions marked on the product and in the documentation before you operate your system. Retain all safety and operating instructions for future use.

- Please read these safety instructions carefully.
- Please keep this User's Manual for later reference.
- The equipment should be operated only from the type of power source indicated on the rating label. Make sure the voltage of the power source when connect the equipment to the power outlet.
- If your equipment has a voltage selector switch, make sure that the switch is in the proper position for your area. The voltage selector switch is set at the factory to the correct voltage.
- For pluggable equipment, that the socket-outlet shall be installed near the equipment and shall be easily accessible.
- Place the power cord such a way that people can not step on it. Do not place anything over the power cord.
- If the equipment is not use for long time, disconnect the equipment from mains to avoid being damaged by transient overvoltage.
- All cautions and warnings on the equipment should be noted.
- Please keep this equipment from humidity.
- Do not use this equipment near water or a heat source.
- Lay this equipment on a reliable surface when install. A drop or fall could cause injury.
- Never pour any liquid into opening; this could cause fire or electrical shock.
- Openings in the case are provided for ventilation. Do not block or cover these openings. Make sure you provide adequate space around the system for ventilation when you set up your work area. Never insert objects of any kind into the ventilation openings.
- To avoid electrical shock, always unplug all power cables and modem cables from the wall outlets before removing covers.
- Lithium Battery provided (real time clock battery)

“CAUTION – Risk of explosion if battery is replaced with one of an incorrect type. Dispose of used batteries according to the instructions”

- If one of the following situations arises, get the equipment checked by a service personnel:
 - The power cord or plug is damaged.
 - Liquid has penetrated into the equipment.
 - The equipment has been exposed to moisture.
 - The equipment has not work well or you can not get it work according to user's manual.
 - The equipment has dropped and damaged.
 - If the equipment has obvious sign of breakage.

Getting Service

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